

Title (en)

METHOD FOR MAKING AN ELECTRICAL OR ELECTRONIC DEVICE WITH A SUPPLY OR COMMUNICATION INTERFACE

Title (de)

VERFAHREN ZUR HERSTELLUNG EINER ELEKTRISCHEN ODER ELEKTRONISCHEN VORRICHTUNG MIT EINER VERSORGUNGS- ODER KOMMUNIKATIONSSCHNITTSTELLE

Title (fr)

PROCEDE DE FABRICATION DE DISPOSITIF ELECTRIQUE OU ELECTRONIQUE A INTERFACE D'ALIMENTATION OU DE COMMUNICATION

Publication

**EP 2926299 A1 20151007 (FR)**

Application

**EP 13799258 A 20131126**

Priority

- EP 12306500 A 20121130
- EP 2013074753 W 20131126
- EP 13799258 A 20131126

Abstract (en)

[origin: EP2738714A1] The method involves providing or producing a set of electrical devices (2A) or electronic devices on a leadframe (1) that is made of rupture-adapted fragile material i.e. fibers, where a thickness of the leadframe is 50-200 micrometer. A preliminary cut (5) is formed in the leadframe about the electrical or electronic devices, where the preliminary cut enables manual separation of the electrical or electronic devices from the leadframe. A set of electronic chips is connected to a set of communication interfaces (10). A case is formed to cover the electronic chips. An independent claim is also included for a leadframe coil.

IPC 8 full level

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CPC (source: EP)

**G06K 19/07718** (2013.01); **G06K 19/07724** (2013.01); **G06K 19/07737** (2013.01); **G06K 19/07743** (2013.01)

Citation (search report)

See references of WO 2014083002A1

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